## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2823 Examiner: Suk San Foong

In Re PATENT APPLICATION Of:

Applicant(s) : Yasuo TANAKA Serial No. 09/660,484 <u>AMENDMENT</u> Filed September 12, 2000 METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE Attorney Ref.: OKI 262 August 23, 2002

Commissioner for Patents Washington, D.C. 20231 **Box - Non-Final Action** 

Sir:

This Amendment is filed in response to the Official Action dated May 23, 2002, the time for response to which is up to and including August 23, 2002. Please amend the above-referenced application as follows.

## IN THE CLAIMS

read as follows:

3.

said bumps respectively.

7. comprising:

lease cancel claims 1, 4-6 and 13, and amena ollows:

(Twice Amended) The method as claimed in claim 7, further comprising: forming external terminals each having conductivity so as to be connected to FCH and GCY CENTER 2800

1 of martufacturing semiconductor devices,

-face of a semiconductor wafer, the plurality of semiconductor devices having a plurality of